# ROYALOHM

CONFIDENTIAL DOCUMENT

SPECIFICATION FOR APPROVAL

## TRELIK

Description: Thick Film Chip Resistor Array (Terminal Lead Free)

**Royalohm Part no.:** 

4D03WGJxxxxT5E (RMC 1/16W (4D03) +/-5% T/R-5,000)

Approved by

Parts corresponding to RoHS Compliant: 2005-Apr.-1

Royal Electronic Factory (Thailand) Co., Ltd. 20/1-2 Moo 2 Klong-Na, Muang Chachoengsao 24000, Thailand Tel: +66-38-822404-8 Fax: +66 38-981190 / 823765

E-mail Address: Export sales: Export@royalohm.com

Local sales: Local@royalohm.com

http://www.royalohm.com

Approved	Checked	Prepared	
Mr. Jack Lin	Mr. S. Polthanasan	Ms.P. Supatta	
	Issue Date: 2015/01/12		

### CONFIDENTIAL DOCUMENT

	CHANGE NOTIFICATION HISTORY						
Version	Date of Version	History	Remark				
1	2015/01/12	Resistance Range: $10\Omega \sim 1M\Omega$					
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# CHANGE NOTIFICATION HISTORY

Customer : TRELIK	Part No.: 4D03WGJxxxxT5E
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#### 1. Scope:

This specification for approval relates to Thick Film Chip Resistor Array (Terminal Lead Free) manufactured by ROYALOHM 's specifications.

#### 2. Type designation:

The type designation shall be in the following form:

	Туре	Power Rating	Resistance tolerance	Nominal Resistance
<u>Ex.</u>	RMC 4D03	0.0625W (1/16W)	J	4.7ΚΩ

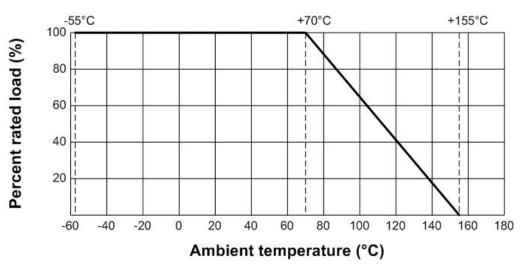
#### 3. Ratings:

Туре	RMC 4D03 (8Pin4R)
Power Rating	0.0625W at 70°C
Max. Working Voltage	50 V
Max. Overload Voltage	100 V
Dielectric Withstanding Voltage	300 V
Temperature Range	$-55^{\circ}\text{C} \sim +155^{\circ}\text{C}$
Ambient Temperature	70 °C
Resistance Range	$10\Omega \sim 1M\Omega$

#### 3.1 Power rating:

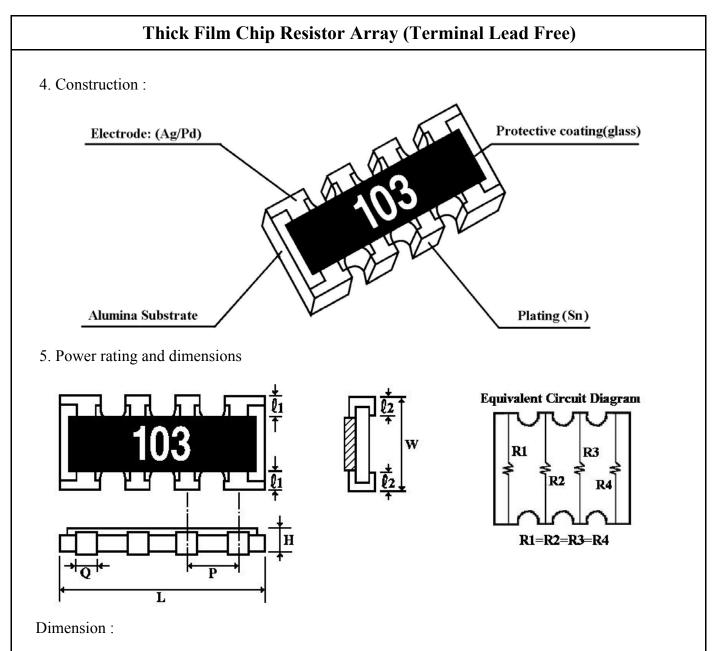
Resistors shall have a power rating based on continuous load operation at an ambient temperature of 70  $^\circ\!C$ . For temperature in excess of 70  $^\circ\!C$ , The load shall be derate as shown in figure 1.





#### 3.2 Nominal Resistance

Effective figures of nominal resistance shall be in accordance with E-24 and E-96 series E-96 series for 1 % and E-24 series for 2 % and 5 %



			Di	mension (mm	)		
Туре	$L \pm 0.20$	$W \pm 0.20$	$H \pm 0.10$	$\ell 1 \pm 0.15$	$\ell_{2} \pm 0.15$	$P \pm 0.10$	Q ± 0.15
RMC 4D03	3.20	1.60	0.50	0.30	0.30	0.8	0.50

Power Rating :

Туре	Power Rating	Tolerance	Resistance	Standard
	at 70 °C	%	Range	Resistance values
RMC 4D03	0.0625 W (1/16W)	± 5	$10\Omega \sim 1M\Omega$	E-24

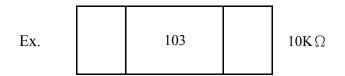
## Thick Film Chip Resistor Array (Terminal Lead Free)

6. Marking :

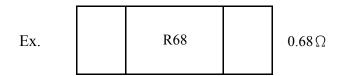
6.1 Resistors

A. Marking for E-24 series in 4D03 size : 3 Digits

\*The first 2 digits are singnificant figures of resistance and the 3rd digit denoted number of zeros.



\*For ohmic values below 10  $\Omega$ , letter"R" is for decimal point.



#### 6.2 Labels

Label shall be marked with the following item :

- A. Nominal Resistance and Resistance Tolerance
- B. Power Rating and Size
- C. Quantity
- D. Part No.
- E. P.O.No.
- F. Lot No.

Ex.

ROYALOHM							
C	CHIP RESISTOR						
RESISTANCE:	4.7K	Ω	± 5 %				
WATTAGE:	1/16W		SIZE: 4D03				
QUANTITY:	5,000	PCS	Pb-Free				
PART NO.:							
P.O.NO.:							
LOT NO. : 605	LOT NO. : 6050008 4D03WGJ0472T5E						

**Remark :** Label is 4K7, value is  $4.7K\Omega$ , marking is 472

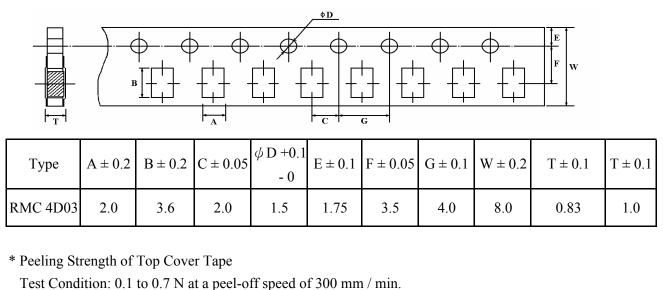
Thick Film Chip Resistor Array (Lead Free)					
7. Performan	ce specification :				
Characteristics	Limits	Test Methods (JIS C 5201-1)			
Insulation resistance	1,000 M $\Omega$ or more	4.6 Apply 500V DC between protective coating and termination for 1 min, then measure			
Dielectric withstanding	No evidence of flashover mechanical damage, arcing or insulation break down	4.7 Apply 500V AC between protective coating and termination for 1 minute			
voltage Temperature coefficient	± 200 PPM/°C	4.8 Natural resistance change per temp. degree centigrade. $\frac{R_2-R_1}{-R_1(t_2-t_1)} \propto 10^6 \text{ (PPM/°C)}$ R1: Resistance value at room temperature (t1) R2: Resistance value at room temp. plus 100 °C (t2)			
Short time overload	Resistance change rate is $\pm (2.0\% + 0.1 \Omega)$ Max.	4.13 Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds			
Solderability	95 % coverage Min. Go up tin rate bigger than	Wave Solder: Test temperature of solder: 245°C ±3°C dipping time in solder : 2-3 seconds. Refolw:			
	half of end pole.	250 245°C - 250°C 200 180°C 150 150°C 90 $\pm$ 30s 100 50 HOT UP TIME SOLDER TIME			
Soldering Heat	Resistance change rate is: ±(1%+0.05Ω) Max.	4.18 Dip the resistor into a solder bath having a temperature of 260°C±3°C and hold it for 10±1 seconds.			

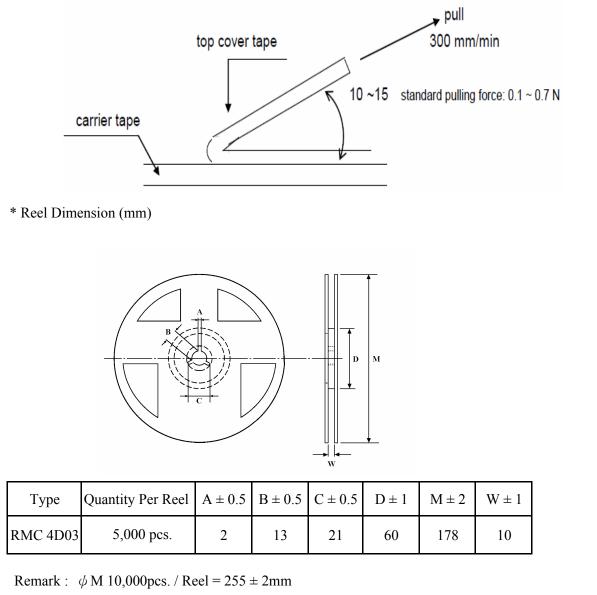
	Thick Film Chip R	esistor Array (I	Lead Free)				
7. Performance	ce specification :						
Characteristics	Limits	Test Methods (JIS C 5201-1)					
		4.19 Resistance change after continuous 5 cycles for duty cycle specified below :					
		Step	Temperature	Time			
Temperature	Resistance change rate is	1	$-55^{\circ}C \pm 3^{\circ}C$	30 mins			
cycling	$\pm (1.0\% + 0.05 \Omega)$ Max.	2	Room temp.	$10\sim 15$ mins			
		3	$+155^{\circ}C \pm 2^{\circ}C$	30 mins			
		4	Room temp.	$10 \sim 15 \text{ mins}$			
		7.9 Resistan	ce change after 1,000 l	nours			
Load life in	Resistance change rate is		on", 0.5 hour "off" ) at				
humidity	$\pm (3.0\% + 0.1 \Omega)$ Max.	-	y chamber controlled a				
·			and 90 to 95 % relative				
	Resistance change rate is	4.25.1 Perm	anent resistance chang	e after 1,000 hours			
Load Life	$\pm (3.0\% + 0.1 \Omega)$ Max.	operating at	RCWV, with duty cyc	le of			
		(1.5 hours"on", 0.5 hour"off") at 70 °C $\pm$ 2 °C ambient					
Terminal	Resistance change rate is	4.33 Twist of Test Board :					
bending	$\pm (1.0\% + 0.05 \Omega)$ Max.	Y/X = 3/90	mm for 60 seconds				

## Thick Film Chip Resistor Array (Terminal Lead Free)

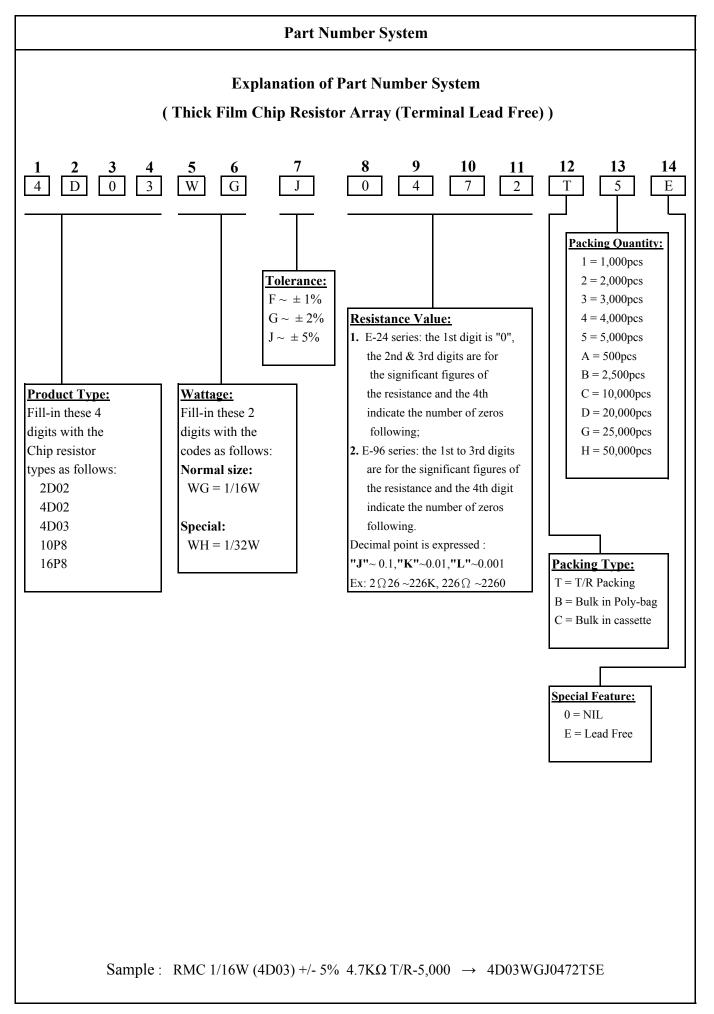
## 8. Packing specification :

\* Taping Dimension (mm)





20,000 pcs. / Reel =  $330 \pm 2$  mm



## Thick Film Chip Resistor Array (Terminal Lead Free)

#### **Environment Related Substance**

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product. This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

#### **Storage Condition**

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of  $25^{\circ}C \pm 5^{\circ}C$  and a relative humidity of 60%RH  $\pm 10\%$ RH

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as  $Cl_2$ ,  $H_2S$ ,  $NH_3$ ,  $SO_2$ , or  $NO_2$ 

2. In direct sunlight